

BUL128

HIGH VOLTAGE FAST-SWITCHING NPN POWER TRANSISTOR

- STMicroelectronics PREFERRED SALESTYPE
- NPN TRANSISTOR
- HIGH VOLTAGE CAPABILITY
- LOW SPREAD OF DYNAMIC PARAMETERS
- MINIMUM LOT-TO-LOT SPREAD FOR RELIABLE OPERATION
- VERY HIGH SWITCHING SPEED

APPLICATIONS:

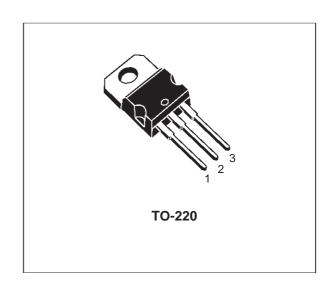
 ELECTRONIC BALLASTS FOR FLUORESCENT LIGHTING

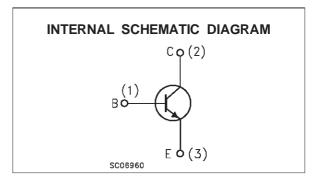
DESCRIPTION

The device is manufactured using high voltage Multi Epitaxial Planar technology for high switching speeds and medium voltage capability.

It uses a Cellular Emitter structure with planar edge termination to enhance switching speeds while maintaining the wide RBSOA.

The device is designed for use in lighting applications and low cost switch-mode power supplies.





ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V _{CES}	Collector-Emitter Voltage (V _{BE} = 0)	700	V
V _{CEO}	Collector-Emitter Voltage (I _B = 0)	400	V
VEBO	Emitter-Base Voltage (Ic = 0)	9	V
Ic	Collector Current	4	А
I _{CM}	Collector Peak Current (t _p < 5 ms)	8	А
I _B	Base Current	2	А
I _{BM}	Base Peak Current (t _p < 5 ms)	4	А
P _{tot}	Total Dissipation at T _c = 25 °C	70	W
T _{stg}	Storage Temperature	-65 to 150	°C
Tj	Max. Operating Junction Temperature	150	°C

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THERMAL DATA

R _{thj-case}	Thermal Resistance Junction-Case	Max	1.78	°C/W
R _{thj-amb}	Thermal Resistance Junction-Ambient	Max	62.5	°C/W

ELECTRICAL CHARACTERISTICS (T_{case} = 25 °C unless otherwise specified)

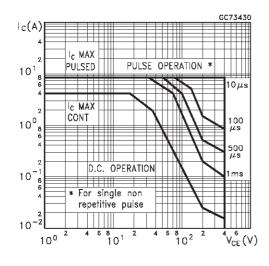
Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
I _{CES}	Collector Cut-off Current (V _{BE} = -1.5 V)	V _{CE} = 700 V V _{CE} = 700 V	T _j = 125 °C			100 500	μA μA
V _{EBO}	Emitter-Base Voltage (Ic = 0)	I _E = 10 mA		9			V
V _{CEO(sus)} *	Collector-Emitter Sustaining Voltage (I _B = 0)	I _C = 100 mA	L = 25 mH	400			V
I _{CEO}	Collector Cut-Off Current (I _B = 0)	V _{CE} = 400 V				250	μΑ
V _{CE(sat)} *	Collector-Emitter Saturation Voltage	I _C = 0.5 A I _C = 1 A I _C = 2.5 A I _C = 4 A	$I_B = 0.1 A$ $I_B = 0.2 A$ $I_B = 0.5 A$ $I_B = 1 A$		0.5	0.7 1 1.5	> > >
V _{BE(sat)*}	Base-Emitter Saturation Voltage	I _C = 0.5 A I _C = 1 A I _C = 2.5 A	$I_B = 0.1 A$ $I_B = 0.2 A$ $I_B = 0.5 A$			1.1 1.2 1.3	V V
h _{FE} *	DC Current Gain	I _C = 10 mA I _C = 2 A Group A Group B	V _{CE} = 5 V V _{CE} = 5 V	10 14 25		28 40	
t _s	RESISTIVE LOAD Storage Time Fall Time	$V_{CC} = 125 \text{ V}$ $I_{B1} = 0.4 \text{ A}$ $T_p = 30 \mu \text{s}$	$I_{C} = 2 A$ $I_{B2} = -0.4 A$ (see fig.2)	1.5	0.2	3 0.4	μs μs
t _s	INDUCTIVE LOAD Storage Time Fall Time	$I_C = 2 A$ $V_{BE(off)} = -5 V$ $V_{clamp} = 200 V$	$I_{B1} = 0.4 \text{ A}$ $R_{BB} = 0 \Omega$ (see fig.1)		0.6 0.1	1 0.2	μs μs

* Pulsed: Pulse duration = 300 µs, duty cycle 1.5 %

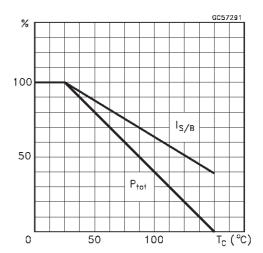
Note: Product is pre-selected in DC current gain (GROUP A and GROUP B). STMicroelectronics reserves the right to ship either groups according to production availability. Please contact your nearest STMicroelectronics sales office for delivery details.

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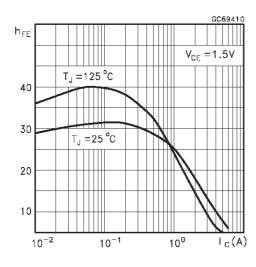
Safe Operating Areas



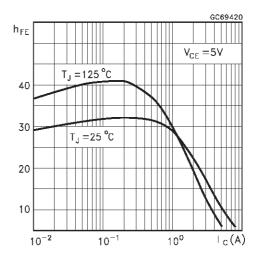
Derating Curve



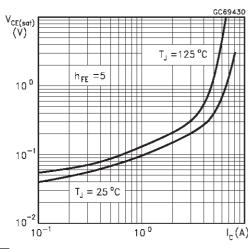
DC Current Gain



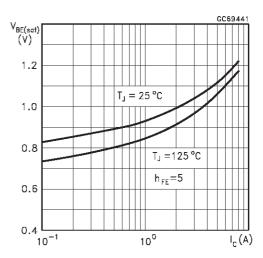
DC Current Gain



Collector Emitter Saturation Voltage

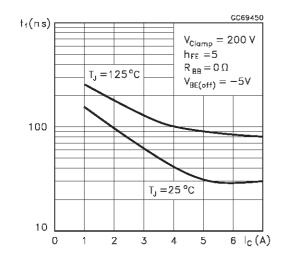


Base Emitter Saturation Voltage

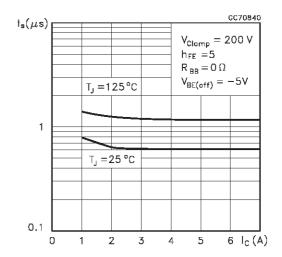


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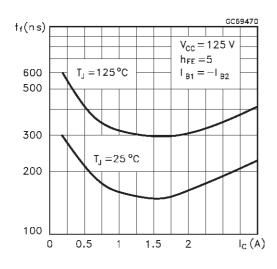
Inductive Load Fall Time



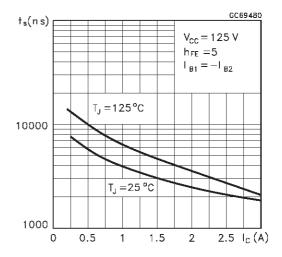
Inductive Load Storage Time



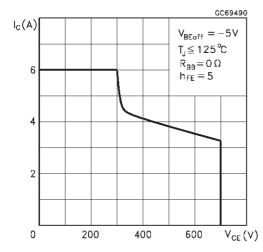
Resistive Load Fall Time



Resistive Load Storage Time



Reverse Biased SOA



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Figure 1: Inductive Load Switching Test Circuit.

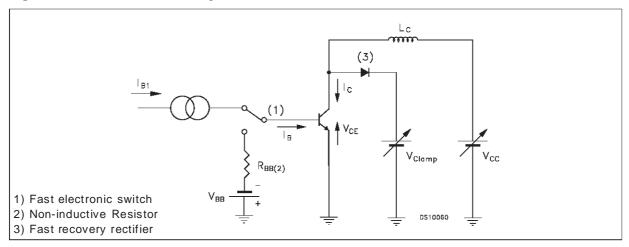
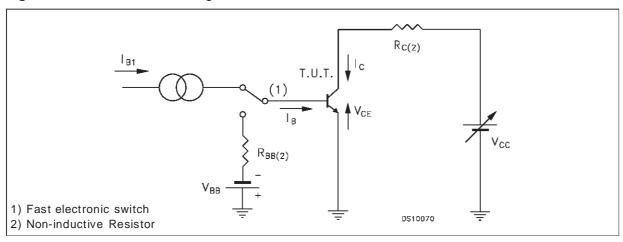
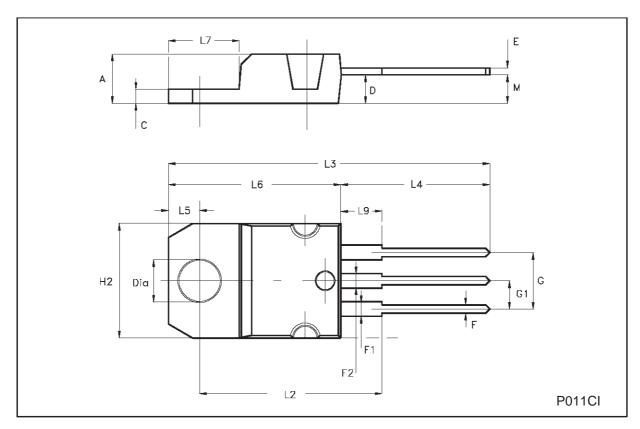


Figure 2: Resistive Load Switching Test Circuit.



TO-220 MECHANICAL DATA

DIM	mm		inch			
DIM.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А	4.40		4.60	0.173		0.181
С	1.23		1.32	0.048		0.052
D	2.40		2.72	0.094		0.107
Е	0.49		0.70	0.019		0.027
F	0.61		0.88	0.024		0.034
F1	1.14		1.70	0.044		0.067
F2	1.14		1.70	0.044		0.067
G	4.95		5.15	0.194		0.202
G1	2.40		2.70	0.094		0.106
H2	10.00		10.40	0.394		0.409
L2		16.40			0.645	
L4	13.00		14.00	0.511		0.551
L5	2.65		2.95	0.104		0.116
L6	15.25		15.75	0.600		0.620
L7	6.20		6.60	0.244		0.260
L9	3.50		3.93	0.137		0.154
М		2.60			0.102	
DIA.	3.75		3.85	0.147		0.151



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